



IGBT Module 75A

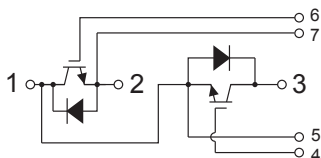
Features

- ◆ Fast switching IGBT trench technology
- ◆ Low switching loss
- ◆ Superfast diodes
- ◆ High short circuit capability

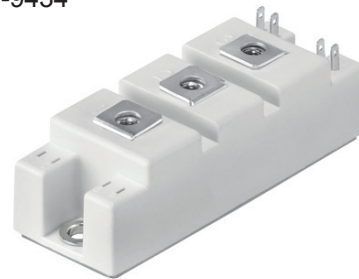
Applications

- ◆ Welder / Power Supply
- ◆ UPS / Inverter
- ◆ Industrial Motor Drive

Preliminary

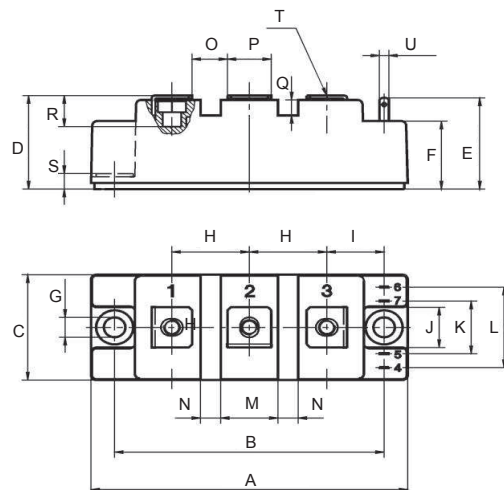


HW-9434



Maximum Ratings (T_C = 25°C)

Item	Symbol	Rated Value	Unit
Collector-Emitter Voltage	V _{CES}	600	V
Gate-Emitter Voltage	V _{GES}	±20	V
DC-Collector Current T _C = 70°C	I _{C,nom.}	75	A
Repetitive Peak Collector Current t _p = 1ms	I _{CRM}	150	A
Total Power Dissipation	P _{tot}	315	W
Isolation Voltag (e Terminal to Base, AC 1 min.)	V _{iso}	2500	V
DC Forward Current	I _F	75	A
Repetitive Peak Forward. Current t _p = 1ms	I _{FRM}	150	A
Junction Temperature Range	T _J	−40~+150	°C
Storage Temperature Range	T _{stg}	−40~+125	°C
Mounting Torque	Module Base to Heatsink	5	N.m
	Busbar to Terminal	5	



DIM	INCHES		MM		NOTE
	MIN	MXA	MIN	MXA	
A	...	3.700	...	94.0	
B	3.134	3.165	79.6	80.4	
C	...	1.339	...	34.0	
D	...	1.201	...	30.5	
E	...	1.181	...	30.0	
F	...	.866	...	22.0	
G	...	.252	...	6.4	Ø
H	.894	.917	22.7	23.3	
I	...	.670	...	17.0	
J	...	.512	...	13.0	
K	...	.677	...	17.2	
L	...	1.024	...	26.0	
M	...	.699	...	17.0	
N	...	.236	...	6.0	
O	...	.413	...	10.5	
P	...	.512	...	13.0	
Q	...	.217	...	5.5	
R	...	.512	...	13.0	
S	...	.197	...	5.0	
T	M5				
U	...	110*20	...	2.8*0.5	



■ Electrical Characteristics ($T_{VJ} = 25^{\circ}\text{C}$)

Characteristic		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Collector-Emitter Cut-Off Current		I_{CES}	$V_{CE} = 600\text{V}$ $V_{GE} = 0\text{V}$	-	1	500	μA
Gate-Emitter Leakage Current		I_{GES}	$V_{GE} = 20\text{V}$ $V_{CE} = 0\text{V}$	-	-	400	nA
Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	$I_C = 75\text{A}$, $V_{GE} = 15\text{V}$	-	1.95	2.45	V
Gate-Emitter Threshold Voltage		$V_{GE(th)}$	$V_{CE} = V_{GE}$, $I_C = 1.5\text{mA}$	4.5	5.5	6.5	V
Input Capacitance		C_{ies}	$V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$	-	6.0	-	nF
Output Capacitance		C_{oes}	$V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$	-	0.52	-	nF
Reverse Transfer Capacitance		C_{res}	$V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$, $f = 1\text{MHz}$	-	0.24	-	nF
Switching Time	Rise Time	t_r	$V_{CC} = 300\text{V}$ $I_C = 75\text{A}$ $R_G = 3\Omega$ $V_{GE} = \pm 15\text{V}$	-	60	-	ns
	Turn-On Time	$t_{d,on}$		-	85	-	
	Fall Time	t_f		-	67	-	
	Turn-Off Time	$t_{d,off}$		-	128	-	
Turn-on Energy Loss Per Pulse		E_{on}	$I_C = 75\text{A}$, $V_{CC} = 300\text{V}$ $V_{GE} = 15\text{V}$, $R_G = 3\Omega$	-	0.35	-	mJ
Turn-off Energy Loss Per Pulse		E_{off}	$T_{VJ} = 25^{\circ}\text{C}$, $L_s = 15\text{nH}$	-	1.9	-	mJ

■ Free Wheeling Diode Ratings & Characteristics ($T_{VJ} = 25^{\circ}\text{C}$)

Characteristic	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Peak Forward Voltage	V_F	$I_F = 75\text{A}$, $V_{GE} = 0\text{V}$	-	1.8	2.5	V
Peak Reverse Recovery Current	I_{RM}	$I_F = 75\text{A}$, $R_G = 3\Omega$ $V_R = 300\text{V}$, $V_{GE} = -15\text{V}$	-	33	-	A
Recovered Charge	Q_r	$I_F = 75\text{A}$, $R_G = 3\Omega$ $V_R = 300\text{V}$, $V_{GE} = -15\text{V}$	-	1.58	-	μC
Reverse Recovery Energy	E_{rec}	$I_F = 75\text{A}$, $R_G = 3\Omega$ $V_R = 300\text{V}$, $V_{GE} = -15\text{V}$	-	0.39	-	mJ
Reverse Recovery Time	T_{rr}	$I_F = 75\text{A}$, $R_G = 3\Omega$ $V_R = 300\text{V}$, $V_{GE} = -15\text{V}$	-	81	-	ns

■ Thermal Characteristics ($T_C = 25^{\circ}\text{C}$)

Characteristic		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Thermal Impedance	IGBT	$R_{th(j-c)}$	Junction to Case	-	-	0.35	$^{\circ}\text{C/W}$
	Diode			-	-	0.60	



Typical Characteristics

Preliminary Data

Fig.1 Output characteristic (Typical)

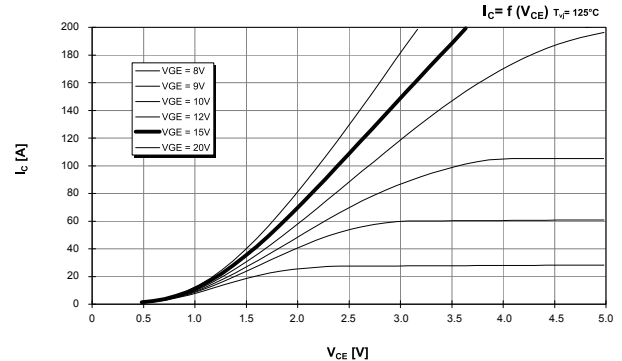
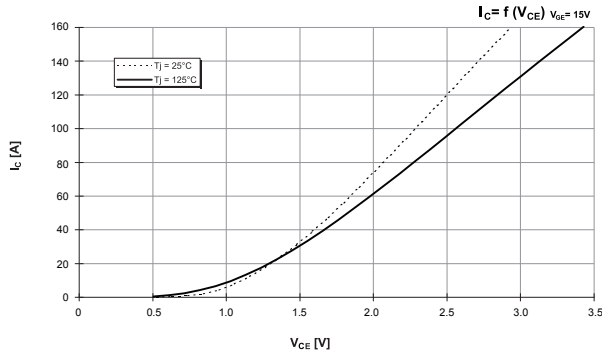


Fig.2 Transfer characteristic (Typical)

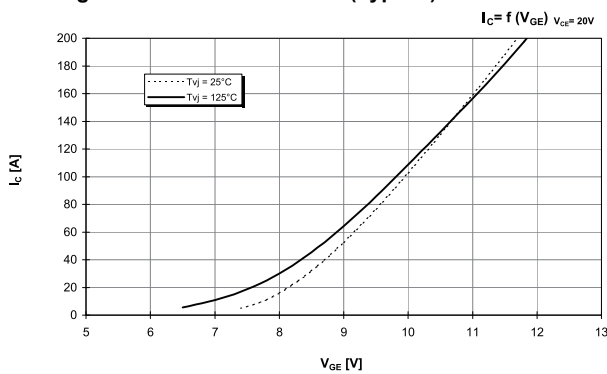


Fig.3 Forward characteristic of inverse diode (typical)

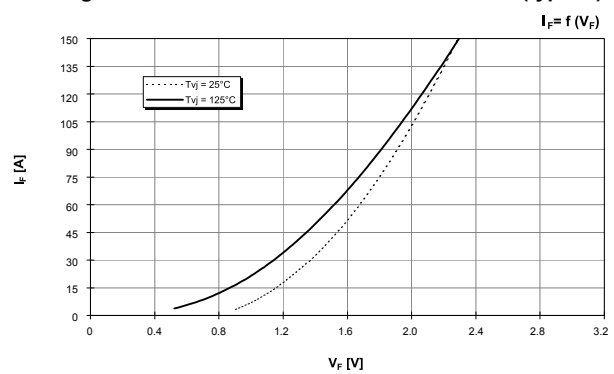


Fig.4 Switching losses (Typical)

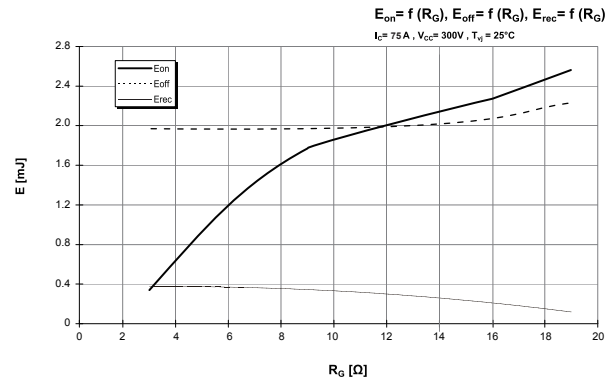
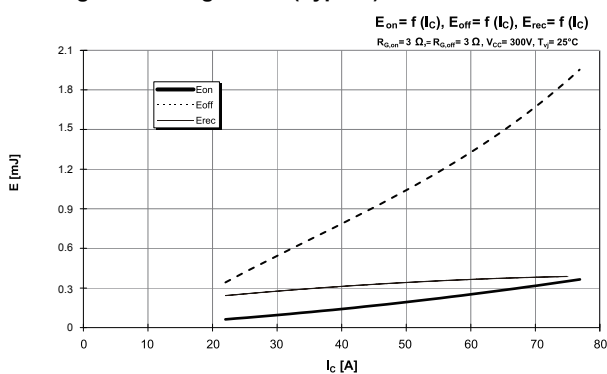


Fig.5 Transient thermal impedance

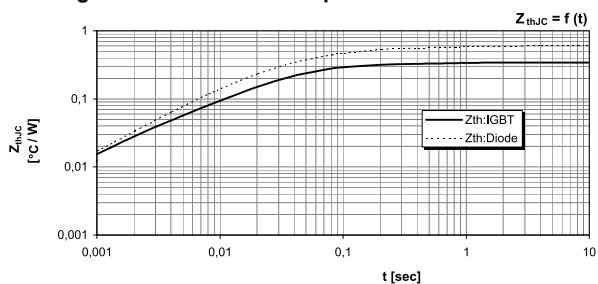


Fig.6 Reverse bias safe operation area (RBSOA)

